

2PD602AQL; 2PD602ARL; 2PD602ASL

50 V, 500 mA NPN general-purpose transistors

Rev. 01 — 27 October 2008

Product data sheet

1. Product profile

1.1 General description

NPN general-purpose transistors in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number[1]	Package	PNP complement	
	NXP	JEDEC	
2PD602AQL	SOT23	OT23 TO-236AB	
2PD602ARL			2PB710ARL
2PD602ASL			2PB710ASL
2PD602AQL/DG	SOT23	TO-236AB	-
2PD602ARL/DG			2PB710ARL/DG
2PD602ASL/DG			2PB710ASL/DG

^{[1] /}DG: halogen-free

1.2 Features

- General-purpose transistors
- Three current gain selections
- AEC-Q101 qualified
- Small SMD plastic package

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	50	V
I _C	collector current		-	-	500	mA



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Table 2. Quick reference data ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
h _{FE}	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	<u>[1]</u>			
	h _{FE} group Q		85	-	170	
	h _{FE} group R		120	-	240	
	h _{FE} group S		170	-	340	

^[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

2. Pinning information

Table 3. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	base	_	
2	emitter	3	3
3	collector	1 2	1 —
			sym021

3. Ordering information

Table 4. Ordering information

Type number[1]	Package				
	Name	Description	Version		
2PD602AQL	-	plastic surface-mounted package; 3 leads	SOT23		
2PD602ARL					
2PD602ASL					
2PD602AQL/DG	-	plastic surface-mounted package; 3 leads	SOT23		
2PD602ARL/DG					
2PD602ASL/DG					

^{[1] /}DG: halogen-free

4. Marking

Table 5. Marking codes

Type number	Marking code ^[1]
2PD602AQL	SH*
2PD602ARL	SG*
2PD602ASL	SF*

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Table 5. Marking codes ...continued

Type number	Marking code ^[1]
2PD602AQL/DG	SX*
2PD602ARL/DG	SW*
2PD602ASL/DG	SV*

^{[1] * = -:} made in Hong Kong

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	60	V
V_{CEO}	collector-emitter voltage	open base	-	50	V
V_{EBO}	emitter-base voltage	open collector	-	5	V
I_{C}	collector current		-	500	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	1	Α
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1] -	250	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T_{stg}	storage temperature		-65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] -	-	500	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

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7. Characteristics

Table 8. Characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A}$	-	-	10	nA
		$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	5	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 4 \text{ V}; I_{C} = 0 \text{ A}$	-	-	10	nA
h _{FE}	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 500 \text{ mA}$	[1] 40	-	-	
	h _{FE} group Q	$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	<u>[1]</u> 85	-	170	
	h _{FE} group R	$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	120	-	240	
	h _{FE} group S	$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	[1] 170	-	340	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 300 \text{ mA};$ $I_B = 30 \text{ mA}$	[1] -	-	600	mV
f _T	transition frequency	$V_{CE} = 10 \text{ V};$ $I_{C} = 50 \text{ mA};$ f = 100 MHz	[1]			
	h _{FE} group Q		140	-	-	MHz
	h _{FE} group R		160	-	-	MHz
	h _{FE} group S		180	-	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V};$ $I_{E} = i_{e} = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	-	15	pF

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

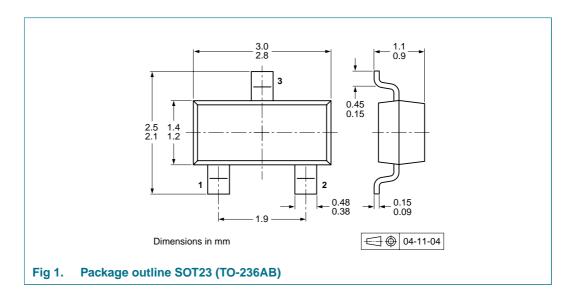
8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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9. Package outline



10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

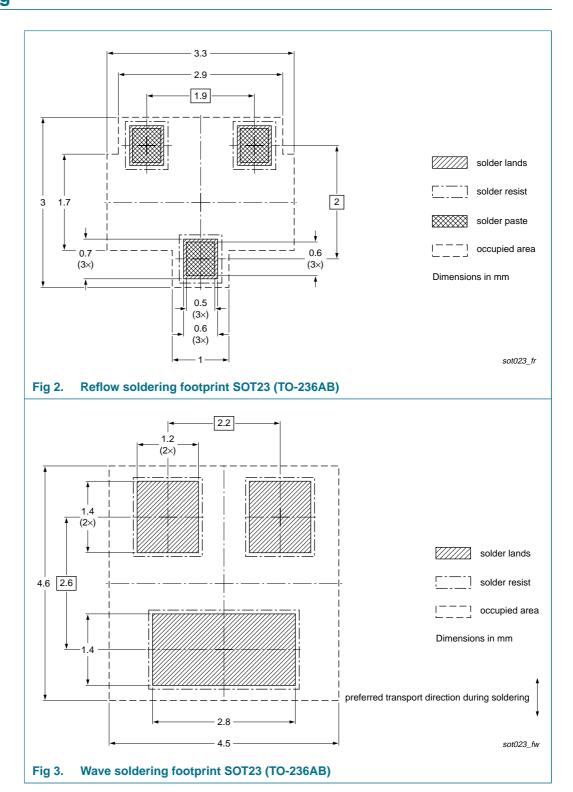
Type number[2]	Package	Description	Packing quantity		
			3000	10000	
2PD602AQL	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235	
2PD602ARL					
2PD602ASL					
2PD602AQL/DG	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235	
2PD602ARL/DG					
2PD602ASL/DG					

^[1] For further information and the availability of packing methods, see Section 14.

^{[2] /}DG: halogen-free

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11. Soldering



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12. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
2PD602AXL_1	20081027	Product data sheet	-	-

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13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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